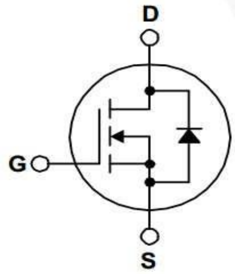
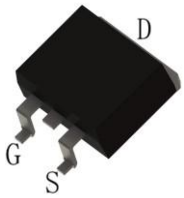
85V N-Channel Power MOSFET

Description

MPT035N08,the N-channel Enhanced Power MOSFETs, Is obtained by advanced double trench technology which reduce the conduction loss,improve switching performance and enhance the avalanche energy. This is suitable device for BMS and high current switching applications.



Schematic diagram



TO-263

TO-220

General Features

① V_{DS}=85V, R_{dson}<4mΩ @V_{GS}=10V, I_D=180A (Typ:3mΩ)
② Fast Switching
③ Low On-Resistance (RDS(on)≤4mΩ)
④ Low Gate Charge
⑤ Low Reverse transfer capacitances
⑥ High avalanche ruggedness
⑦ RoHS product

Application

① BMS
② Motor drivers

Package Marking And Ordering Information：

Ordering Codes	Package	Product Code	Packing
MPT035N08-P	TO-220	035N08	Tube
MPT035N08-S	TO-263	035N08	Tape Reel

ABSOLUTE RATINGS at TC=25°C， unless otherwise specified

Symbol	Parameter	Rating	Units
V_{DSS}	Drain-Source Voltage	85	V
I_D	Continuous Drain Current, Silicon Limited	185	A
	Continuous Drain Current, Package Limited	120	A
	Continuous Drain Current @T_C=100°C, Silicon Limited	117.2	A
I_{DM} Note1	Pulsed Drain Current	480	A
V_{GS}	Gate-Source Voltage	±20	V
E_{AS} Note2	Avalanche Energy	240.2	mJ

PD	Power Dissipation	208.3	W
	Derating Factor above 25°C	1.67	W/℃
T_J, T_{stg}	Operating Junction and Storage Temperature Range	150, –55 to 150	℃
T_L	Maximum Temperature for Soldering	260	℃

Note1：Repetitive Rating：Pulse width limited by maximum junction temperature Note2：L=0.5mH, Ias=35A, Start T_J=25℃

Thermal characteristics

Symbol	Parameter	Max	Units
$R_{\theta JC}$	thermal resistance, Junction-Case	0.5	℃/W
$R_{\theta JA}$	thermal resistance, Junction-Ambient	62.5	℃/W

Electrical Characteristics at TC=25°C, unless otherwise specified

OFF Characteristics

Symbol	Parameter	Test Conditions	Values			Units
			Min	Typ	Max	
V_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V, I_D=250μA	85	95	--	V
I_{DSS}	Drain-Source Leakage Current	V_{DS}=100V, V_{GS}=0V	--	--	1	μA
		V_{DS}=80V, V_{GS}=0V @T_C=125°C	--	--	100	μA
$I_{GSS(F)}$	Gate-Source Forward Leakage	V_{GS}=+20V	--	--	100	nA
$I_{GSS(R)}$	Gate-Source Reverse Leakage	V_{GS}=-20V	--	--	-100	nA

ON Characteristics

Symbol	Parameter	Test Conditions	Values			Unit s
			Min	Typ	Max	
$R_{DS(on)}$	Drain-Source On-Resistance	V_{GS}=10V, I_D=50A	--	3	4	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=250μA	2.0	3.0	4.0	V
Pulse width tp≤300μs, δ≤2%						

Dynamic Characteristics

Symbol	Parameter	Test Conditions	Values			Units
			Min	Typ	Max	
C_{iss}	Input Capacitance	V_{DS}=42.5V, V_{GS}=0, f=1MHz	--	6234	--	pF
C_{oss}	Output Capacitance		--	1181	--	
C_{rss}	Reverse Transfer Capacitance		--	97	--	
Q_g	Total Gate Charge	V_{DD}=42.5V, I_D=50A, V_{GS}=10V	--	124	--	nC
Q_{gs}	Gate-Source charge		--	31.2	--	
Q_{gd}	Gate-Drain charge		--	39.2	--	

Switching Characteristics

Symbol	Parameter	Test Conditions	Values			Units
			Min	Typ	Max	
$t_{d(on)}$	Turn-On Delay Time	V_{DD}=42.5V, I_D=10A, V_{GS}=10V, R_G=3Ω, Resistive Load	--	41	--	ns
t_r	Rise Time		--	68	--	
$t_{d(off)}$	Turn-Off Delay Time		--	76	--	
t_f	Fall Time		--	44	--	

Source-Drain Diode Characteristics

Symbol	Parameter	Test Conditions	Values			Units
			Min	Typ	Max	
I_S	Continuous Source Current		--	--	120	A
I_{SM}	Maximum Pulsed Current		--	--	480	A
V_{SD}	Diode Forward Voltage	V_{GS}=0V, I_S=50A	--	--	1.2	V
T_{rr}	Reverse Recovery Time	I_s=30A， di/dt=100A/us	--	80	--	ns
Q_{rr}	Reverse Recovery Charge		--	112	--	uC

Characteristics Curves

Figure 1. Safe Operating Area

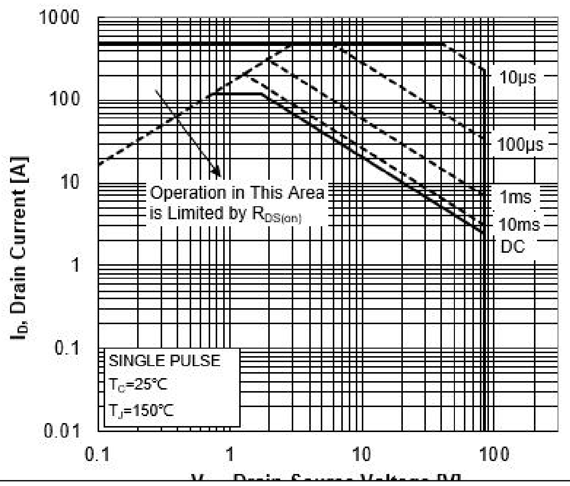


Figure 2. Maximum Power Dissipation vs Case

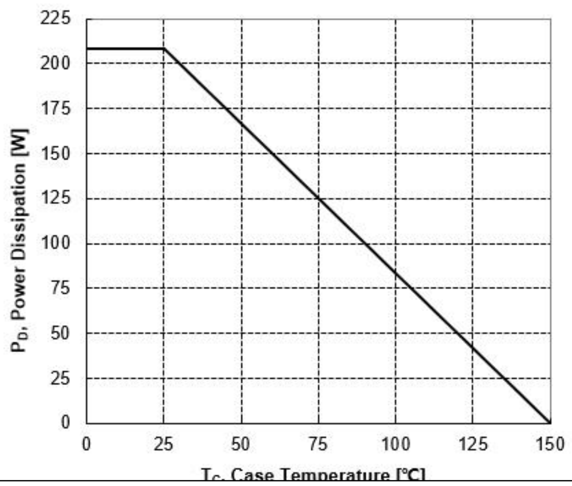


Figure 3. Maximum Continuous Drain Current vs Case Temperature

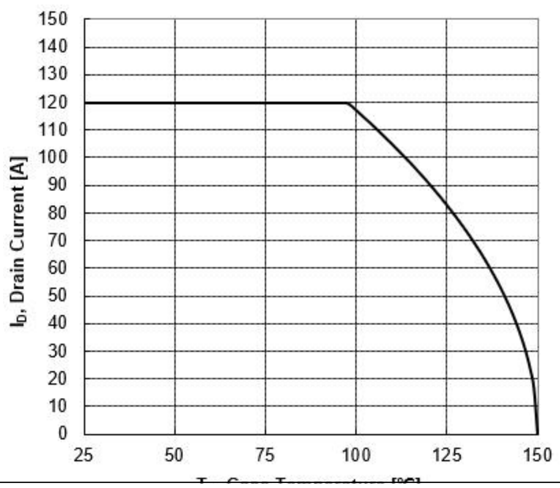


Figure 4. Typical Output Characteristics

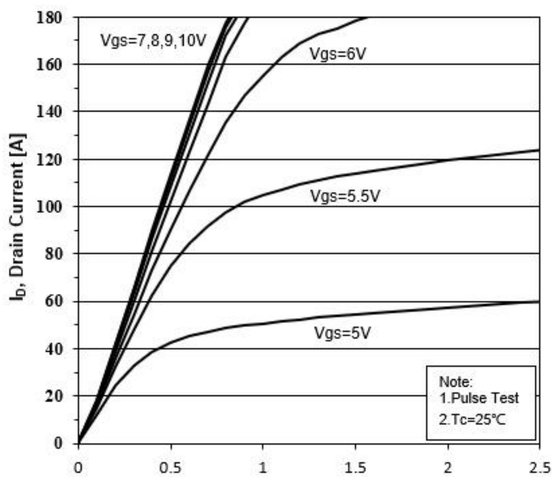


Figure 5. Transient Thermal Impedance

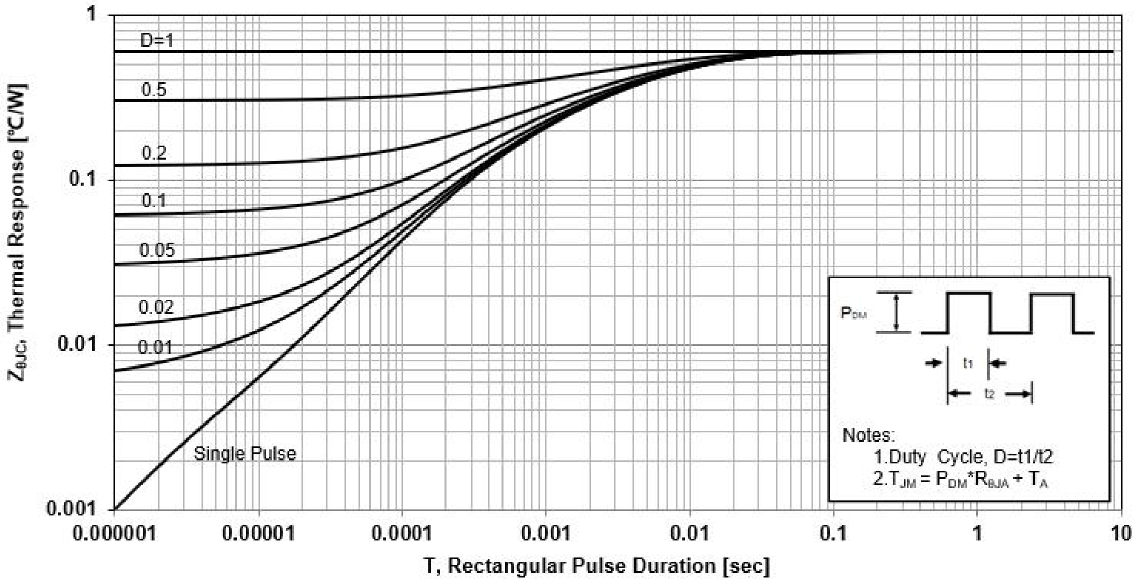


Figure 6. Typical Transfer Characteristics

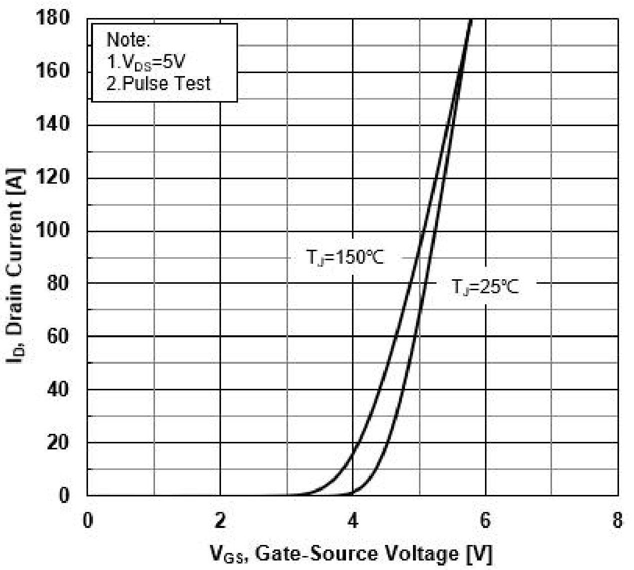


Figure 7. Source-Drain Diode Forward Characteristics

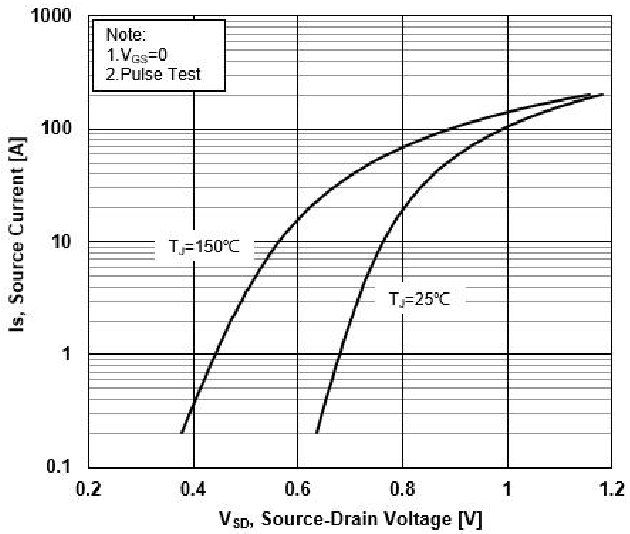


Figure 8. Drain-Source On-Resistance vs Drain Current

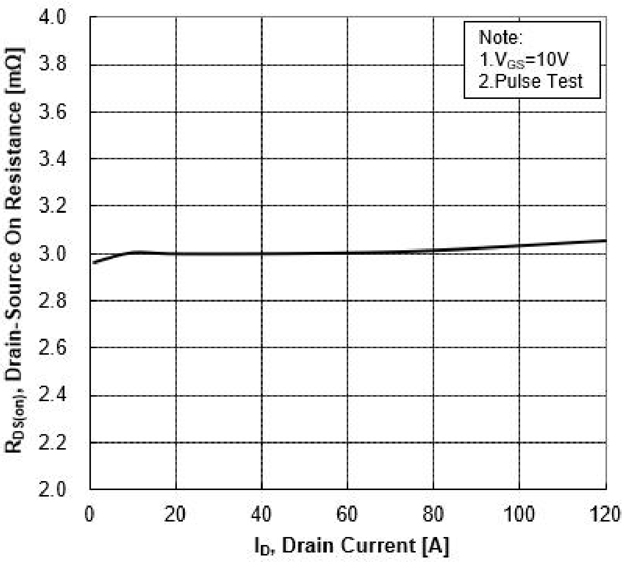


Figure 9. Normalized On-Resistance vs Junction Temperature

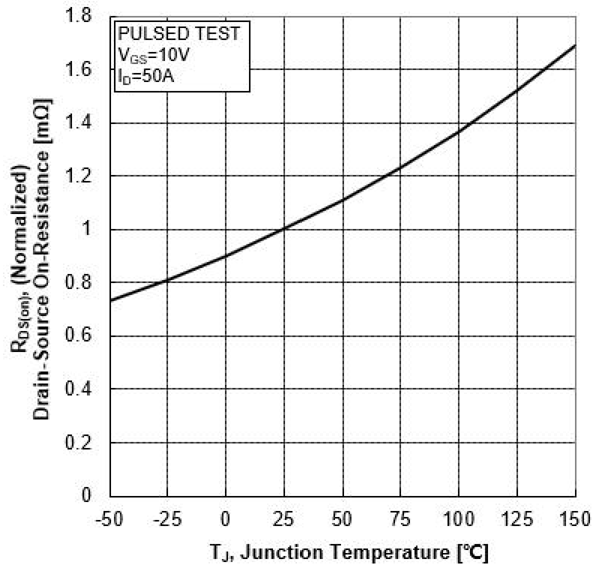


Figure 10. Normalized Threshold Voltage vs Junction Temperature

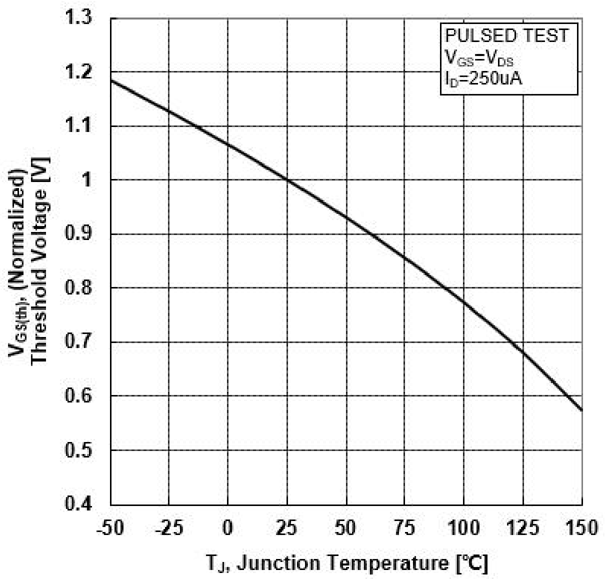


Figure 11. Normalized Breakdown Voltage vs Junction Temperature

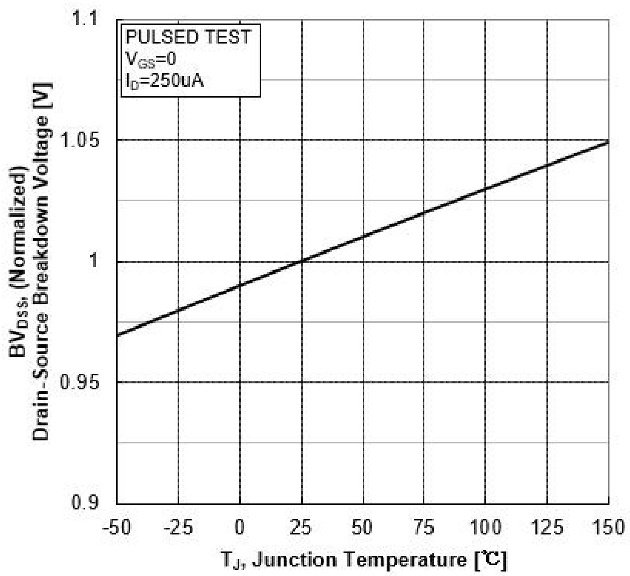
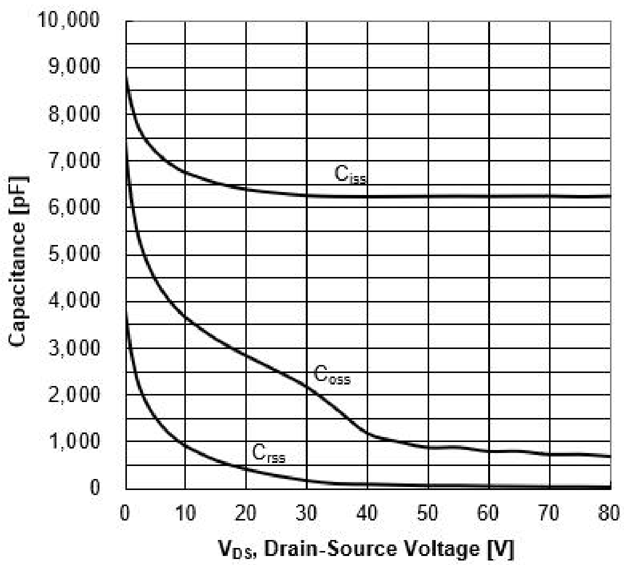
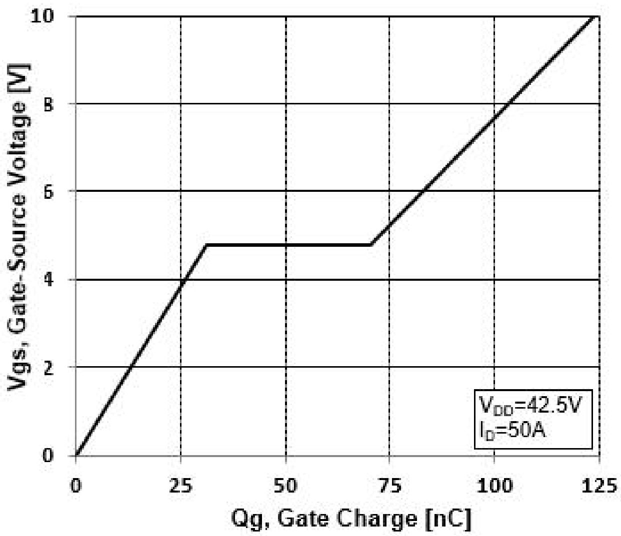


Figure 12. Capacitance Characteristics	Figure 13. Typical Gate Charge vs Gate-Source Voltage
	

Test Circuit and Waveform

Figure 14. Resistive Switching Test Circuit

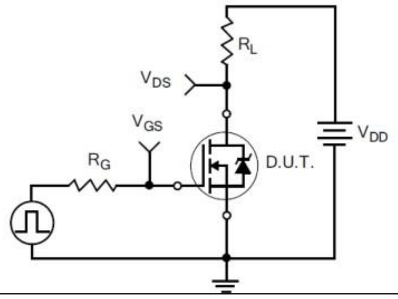


Figure 15. Resistive Switching Waveforms

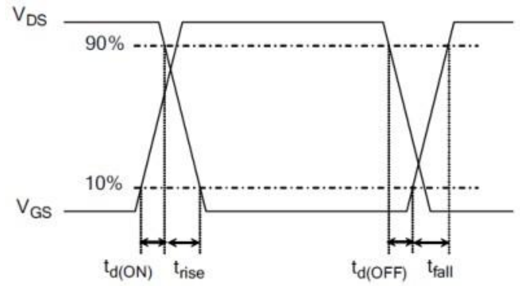


Figure 16. Gate Charge Test Circuit

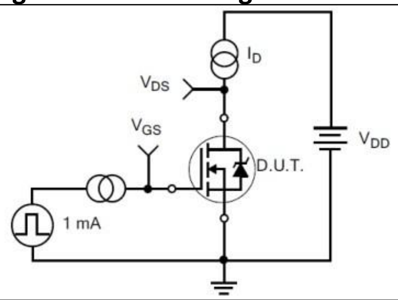


Figure 17. Gate Charge Waveforms

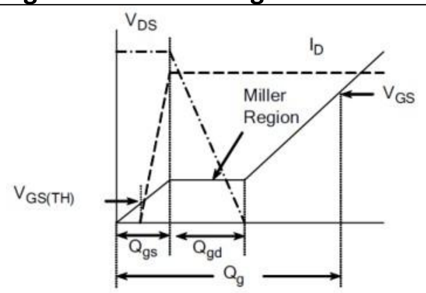


Figure 18. Diode Reverse Recovery Test Circuit

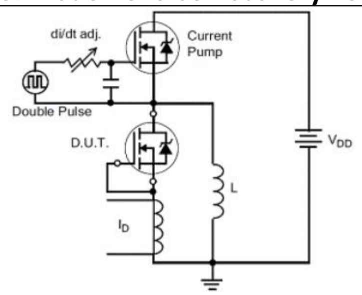


Figure 19. Diode Reverse Recovery Waveform

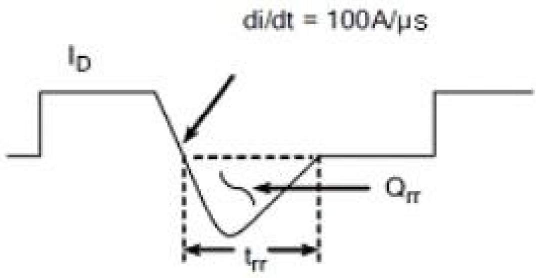


Figure 20. Unclamped Inductive Switching Test Circuit

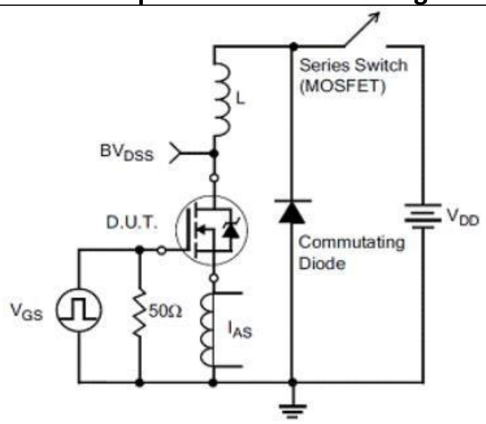
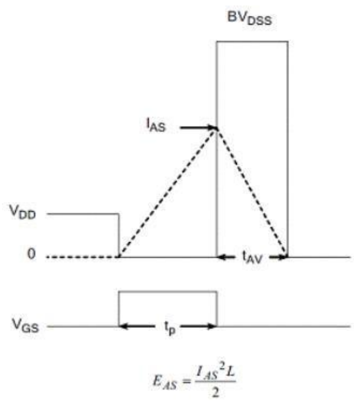
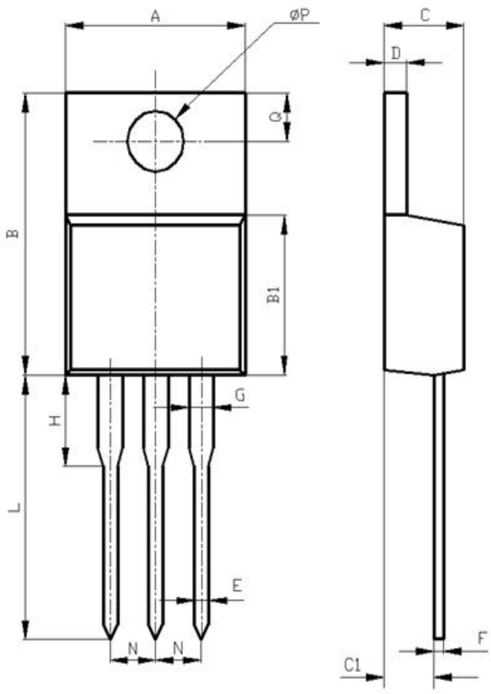


Figure 21. Unclamped Inductive Switching Waveform

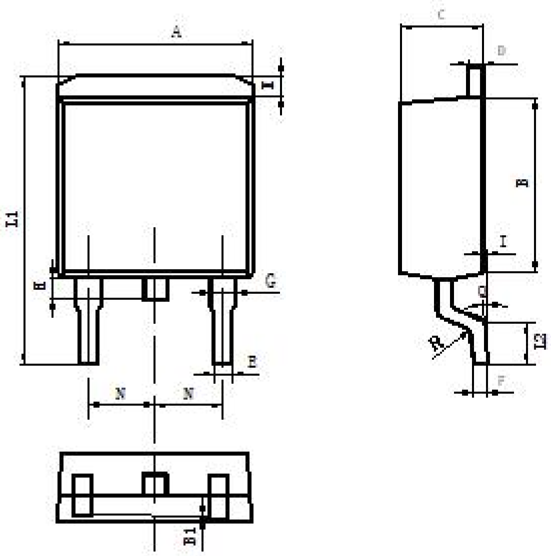


Package Description



Items	Values(mm)	
	MIN	MAX
A	9.60	10.6
B	15.0	16.0
B1	8.90	9.50
C	4.30	4.80
C1	2.30	3.10
D	1.20	1.40
E	0.70	0.90
F	0.30	0.60
G	1.17	1.37
H	2.70	3.80
L	12.6	14.8
N	2.34	2.74
Q	2.40	3.00
ΦP	3.50	3.90

TO-220 Package



Items	Values(mm)	
	MIN	MAX
A	9.80	10.40
B	8.90	9.50
B1	0	0.10
C	4.40	4.80
D	1.16	1.37
E	0.70	0.95
F	0.30	0.60
G	1.07	1.47
H	1.30	1.80
K	0.95	1.37
L1	14.50	16.50
L2	1.60	2.30
I	0	0.2
Q	0°	8°
R	0.4	
N	2.39	2.69

TO-263 Package

NOTE:

1. Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. Please do not exceed the absolute maximum ratings of the device when circuit designing.
2. When installing the heat sink, please pay attention to the torsional moment and the smoothness of the heat sink.
3. MOSFETs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it.
4. Shenzhen Minos reserves the right to make changes in this specification sheet and is subject to change withoutprior notice.

CONTACT:

深圳市迈诺斯科技有限公司（总部）

地址：深圳市福田区华富街道田面社区深南中路4026号田面城市大厦22B-22C

邮编：518025

电话：0755-83273777